

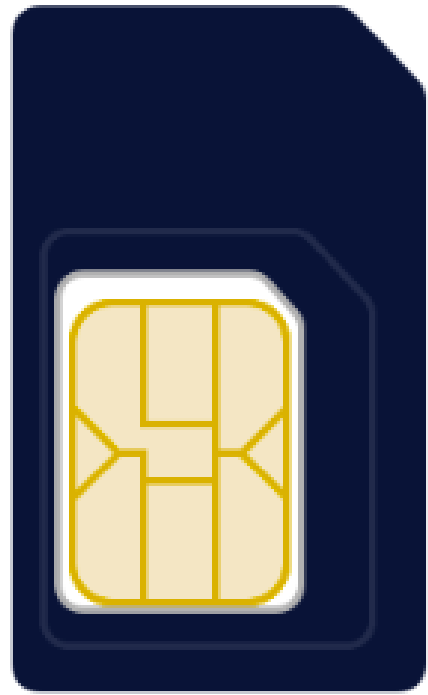


Taoglas IoT Solutions

Connectivity / eSIM Introduction

Aug 2022

Physical SIM Types



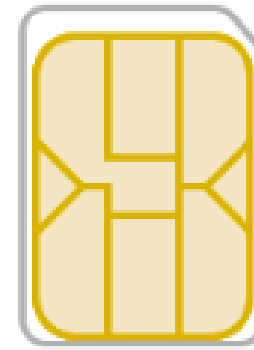
2FF - Mini SIM

Height: 25mm
Width: 15mm
Thickness: 0.76mm



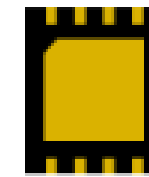
3FF - Micro SIM

Height: 15mm
Width: 12mm
Thickness: 0.76mm



4FF - Nano SIM

Height: 12.3mm
Width: 8.8mm
Thickness: 0.67mm



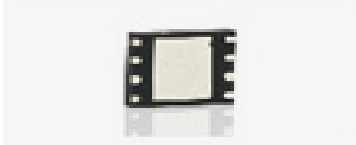


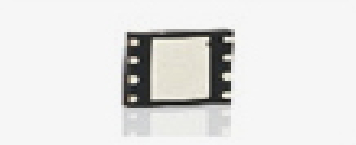
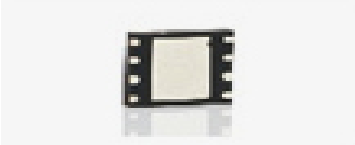






MFF2 - M2M Form Factor (eSIM)

Height: 6.0mm
Width: 5.0mm
Thickness: 0.67mm

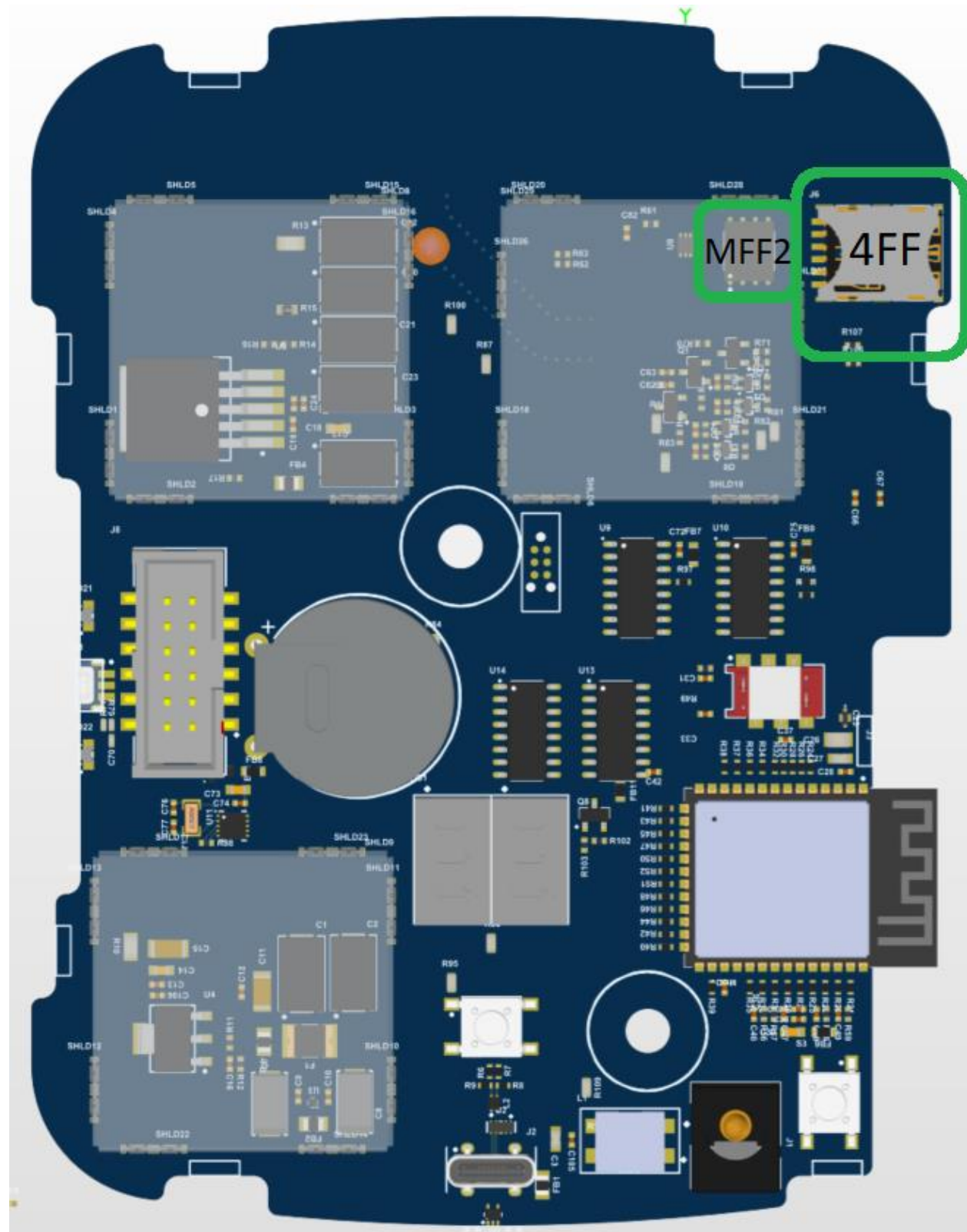
Also commonly called:

- Chip SIM
- eSIM
- Soldered SIM
- etc



Product Family	U-MIM Quad	M2M ^{Plug} 85	M2M ^{Plug} 105	Full M2M Quad	Full Auto Quad
Drivers	Miniaturisation	Fit any equipment	Fit any equipment	Industrial grade	Auto grade
	M2M Consumer Electronics	M2M Industrial	M2M Industrial Extended endurance	M2M Industrial Extended endurance	Automotive std Extended endurance
					
Temperature resistance range	GSM standard	- 25°C / +85°C	- 40°C / +105°C	- 40°C / +105°C	- 40°C / +105°C
M2M qualification (JEDEC)			•	•	•
eXtended Life mechanism	as an option	•	•	•	•
Enhanced silicon		•	•	•	•
Burn-in					•
Data retention	10 y / 25°	10 y / 85°	10 y / 85°	10 y / 25°	17 y / 80°
Automotive req compliancy				 	AEC Q100 / TS 16 949   
	https://www.thalesgroup.com/en/markets/digital-identity-and-security/iot/iot-connectivity/industrial-sim				

Lynx Proto 1.0



- 1 Plastic 4FF SIM slot
- Ability to have MFF2 soldered instead of 4FF
- Closer to MP, 4FF or MFF2 can be selected/populated



What is eSIM ?

- eSIM is a complex technology NOT just a MFF2 chip SIM
- eSIM technology provides Remote SIM Provisioning
- SIM has not changed, the way its loaded has changes
- Now you can download a “SIM” or profile” into a secure element (eUICC)



More info:

<https://www.gsma.com/iot/embedded-sim/>

<https://ec.europa.eu/digital-single-market/en/ecall-time-saved-lives-saved>

<https://infocentre2.gsma.com/gp/og/STF/CRT/Pages/GSMA-RSP-Compliance-Products.aspx>

<http://simalliance.org/euicc/euicc-technical-releases/>

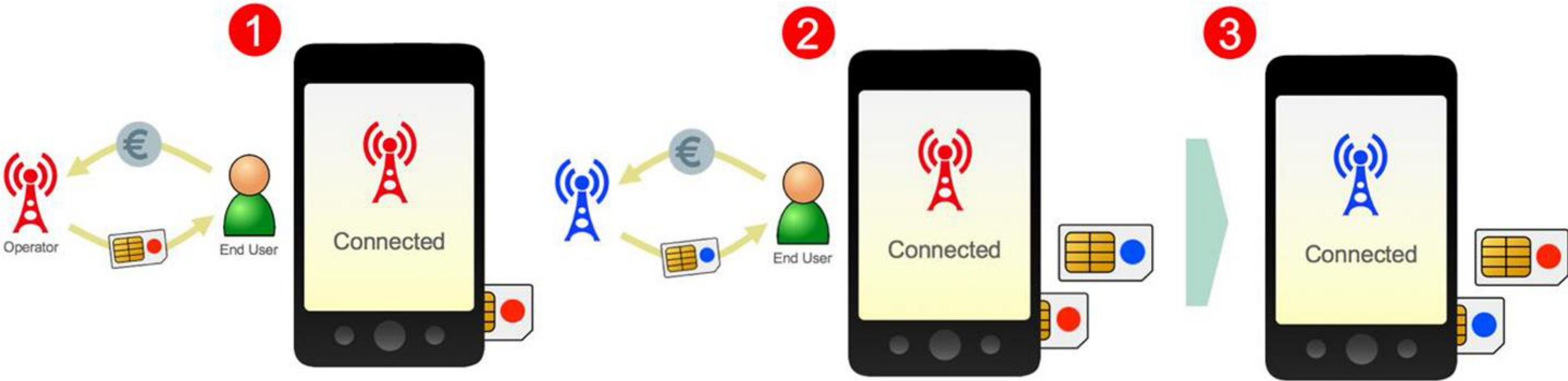


SIM Cards Today - Example

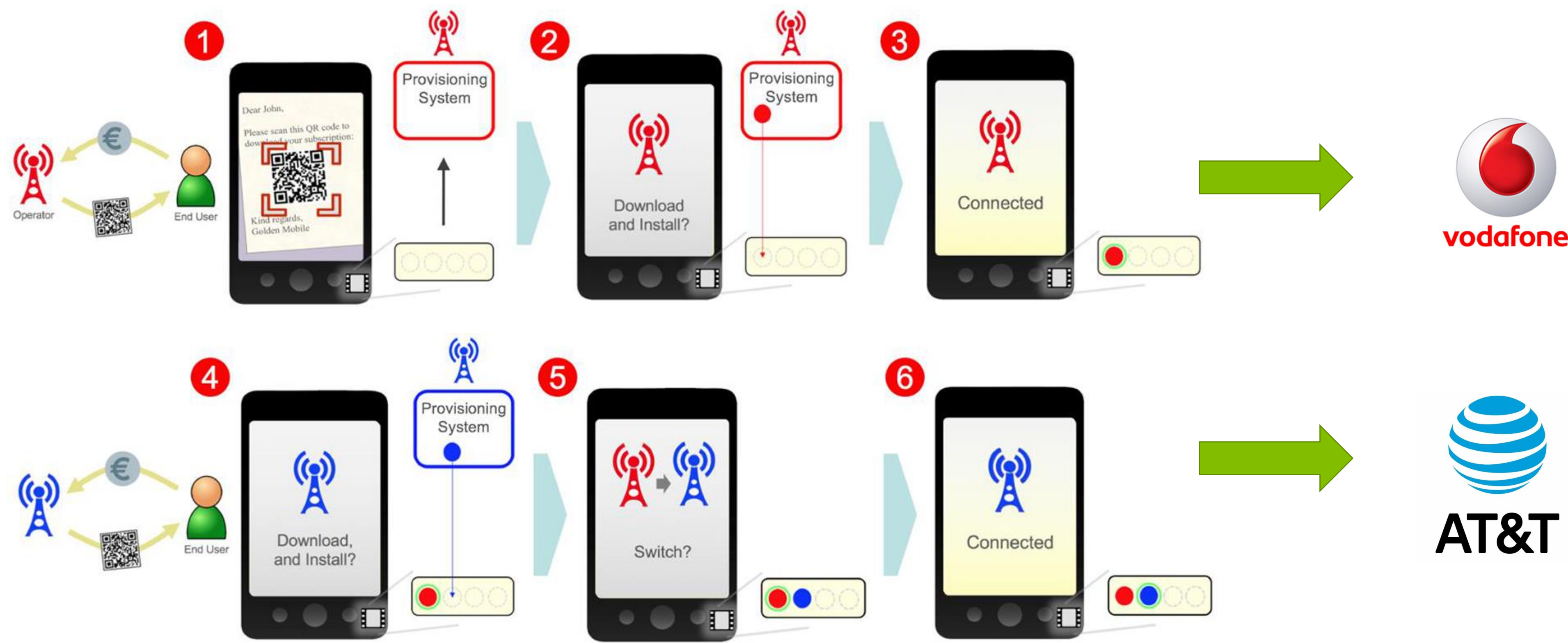


Setup Contract with Voda

Setup Contract with AT&T



eSIM Example Scenario – No Physical SIM swapping



Why eSIM was Needed



SKU explosion

Maintaining too many product variants increases production and logistic costs

Complex Manufacturing



Complex installation

Technicians need to test connectivity before deploying in the field

Complex and Lengthy Installation



Business continuity

Service providers need to ensure uninterrupted connectivity throughout the lifetime of the IoT device

Unreliable Connectivity



Long Term Insurance

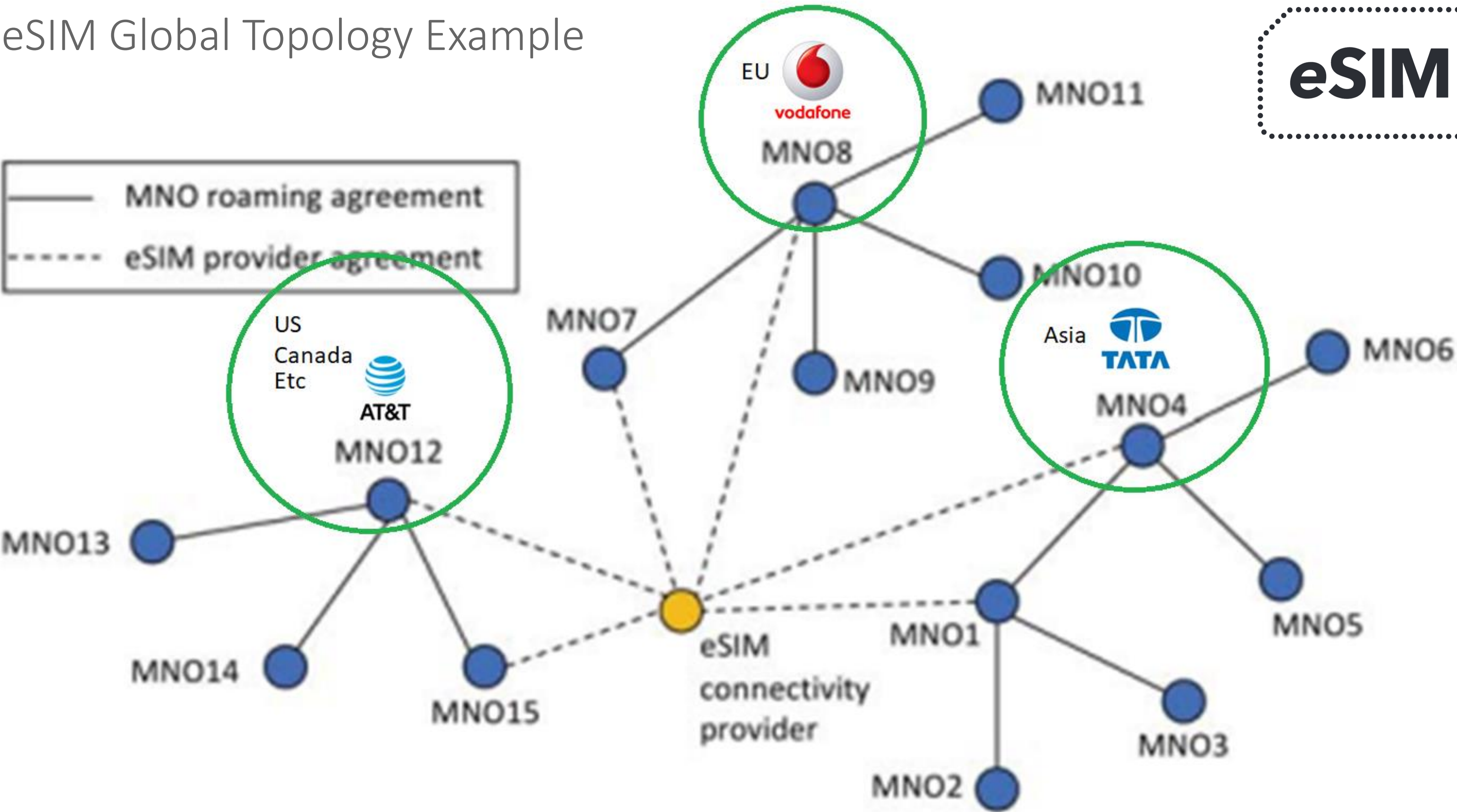
Service providers need to keep the control versus technology sunset and MNO contract termination

Unpredictability

Credit : <https://www.thalesgroup.com/en/digital-identity-and-security-0>

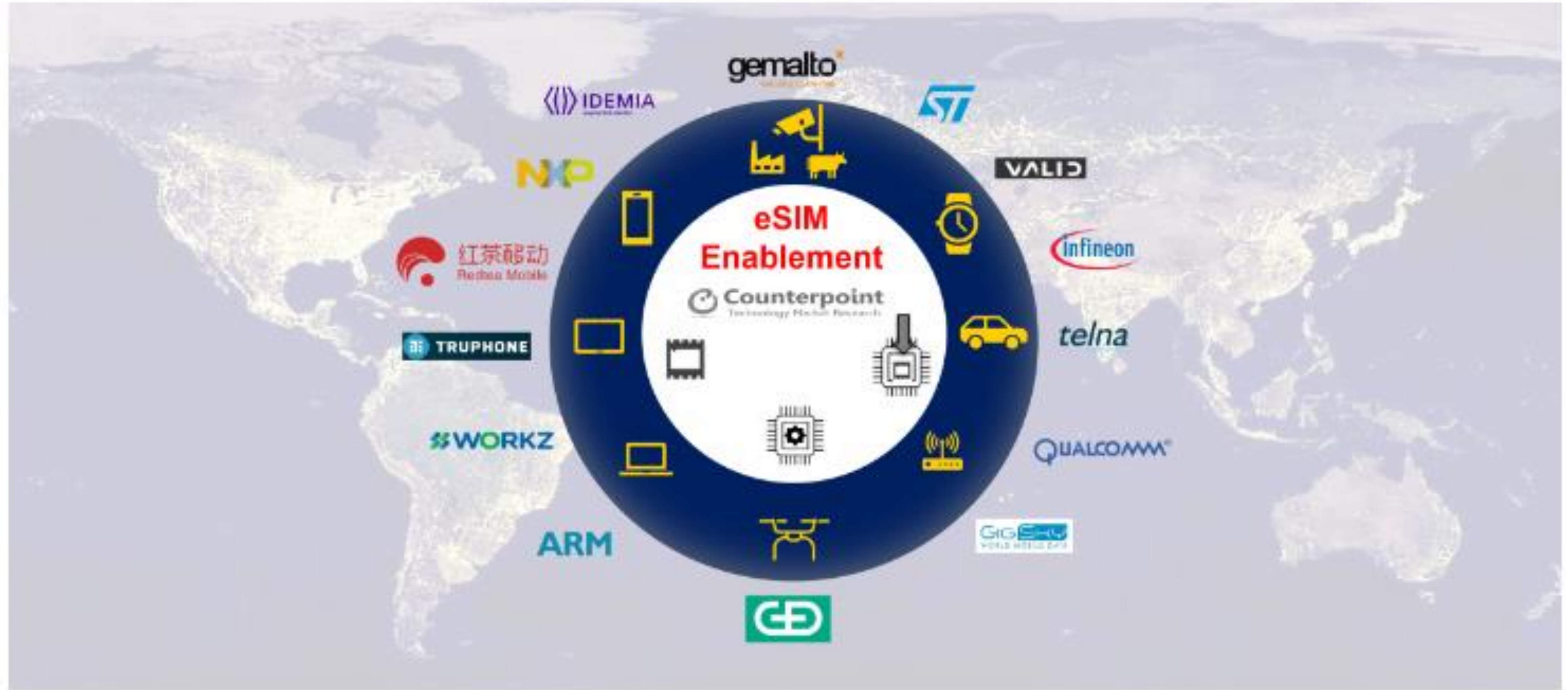


eSIM Global Topology Example



eSIM Solution Platform Providers

<https://www.gsma.com/security/sas-accredited-sites/>



Example Taoglas eSIM Platform and/or Connectivity Providers



<https://www.thalesgroup.com/en/digital-identity-and-security-0>



<https://www.twilio.com/iot/super-sim-card>



<https://www.korewireless.com/>



<https://www.tealcom.io/>





www.taoglas.com